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Standard Avalanche SMD Rectifier



SMA (DO-214AC)

FEATURES

- Low profile package
- Ideal for automated placement
- Controlled avalanche characteristics
- Glass passivated pellet chip junction
- Low reverse current
- High surge current capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHE3 or P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE Available

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.5 A
V_{RRM}	200 V, 400 V, 600 V, 800 V, 1000 V, 1600 V
I_{FSM}	30 A
I_R	1.0 μ A
V_F	1.15 V
E_R	20 mJ
T_J max.	150 °C
Package	SMA (DO-214AC)
Circuit configuration	Single

TYPICAL APPLICATIONS

For use in general purpose rectification of power supplies, inverters, converters, and freewheeling diodes for consumer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-E3 - RoHS-compliant, commercial grade

Base P/N-M3 - halogen-free, RoHS-compliant, commercial grade

Base P/NHE3_X - RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

Base P/NHM3_X - halogen-free, RoHS-compliant and AEC-Q101 qualified

("_X" denotes revision code e.g. A, B,...)

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3, M3, HE3, HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)								
PARAMETER	SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Device marking code		BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	
Maximum repetitive peak reverse voltage	V_{RRM}	200	400	600	800	1000	1600	V
Average forward current	$I_{F(AV)}$	1.5						A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	30						A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R} = 1\text{ A}$, $T_J = 25\text{ °C}$ (for BYG10D thru BYG10M) $I_{(BR)R} = 0.4\text{ A}$, $T_J = 25\text{ °C}$ (for BYG10Y)	E_R	20						mJ
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150						°C



ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT
Maximum instantaneous forward voltage ⁽¹⁾	I _F = 1 A	T _J = 25 °C	V _F	1.1						V
	I _F = 1.5 A			1.15						
Maximum DC reverse current	V _R = V _{RRM}	T _J = 25 °C	I _R	1						μA
		T _J = 100 °C		10						
Maximum reverse recovery time	I _F = 0.5 A, I _R = 1.0 A, I _{rr} = 0.25 A		t _{rr}	4						μs

Note

⁽¹⁾ Pulse test: 300 μs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER	SYMBOL	BYG10D	BYG10G	BYG10J	BYG10K	BYG10M	BYG10Y	UNIT		
Typical thermal resistance, junction to lead	R _{θJL}	25							°C/W	
Typical thermal resistance, junction to ambient	R _{θJA} ⁽¹⁾	150							°C/W	
	R _{θJA} ⁽²⁾	125								
	R _{θJA} ⁽³⁾	100								

Notes

- ⁽¹⁾ Mounted on epoxy-glass hard tissue
- ⁽²⁾ Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- ⁽³⁾ Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μm Cu

ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
BYG10M-E3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG10M-E3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG10MHE3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG10MHE3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel
BYG10M-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG10M-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG10MHM3_A/H ⁽¹⁾	0.064	H	1800	7" diameter plastic tape and reel
BYG10MHM3_A/I ⁽¹⁾	0.064	I	7500	13" diameter plastic tape and reel

Note

⁽¹⁾ AEC-Q101 qualified



RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

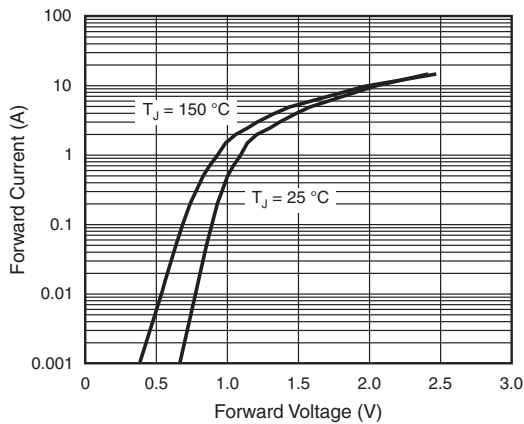


Fig. 1 - Forward Current vs. Forward Voltage

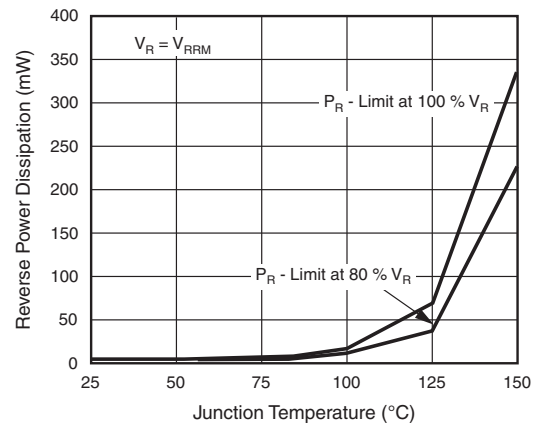


Fig. 4 - Max. Reverse Power Dissipation vs. Junction Temperature

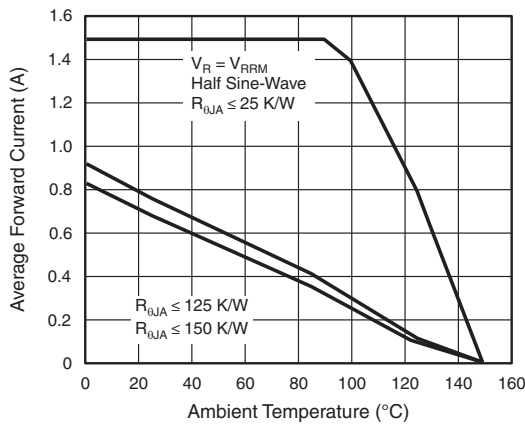


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

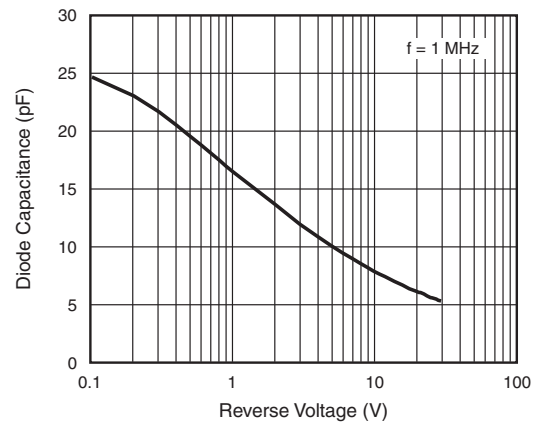


Fig. 5 - Diode Capacitance vs. Reverse Voltage

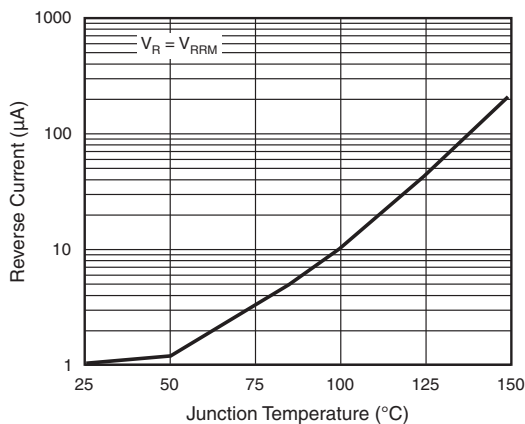


Fig. 3 - Reverse Current vs. Junction Temperature

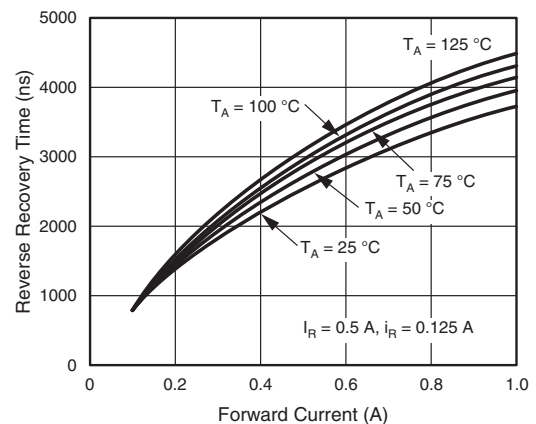


Fig. 6 - Reverse Recovery Time vs. Forward Current

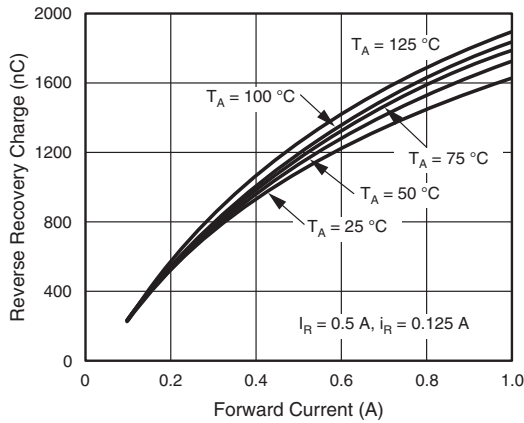
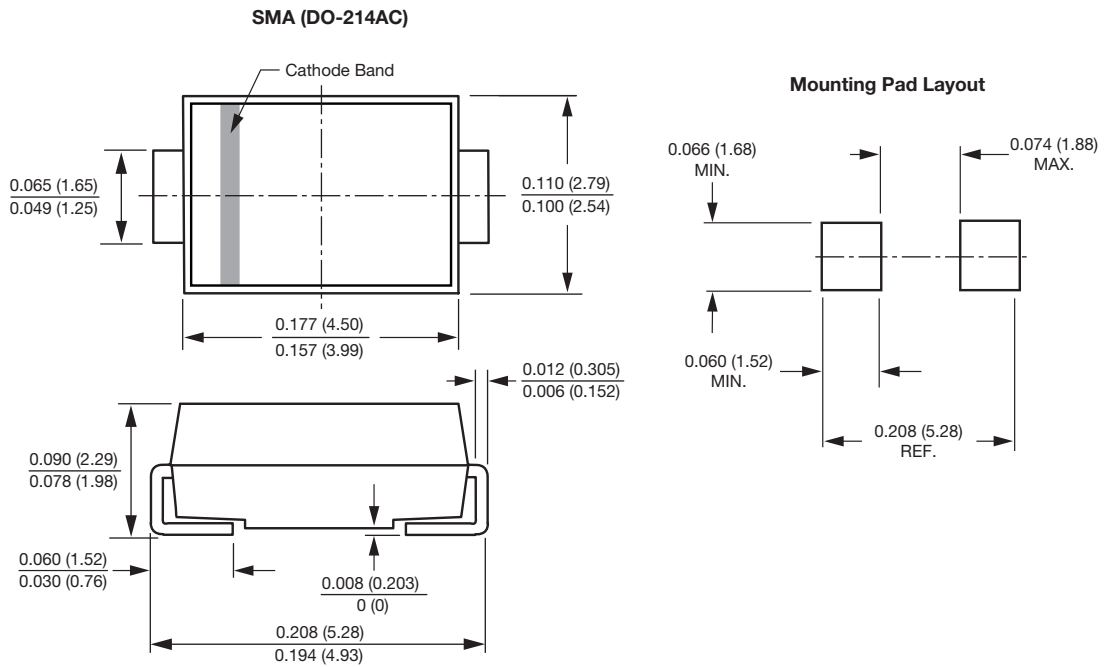


Fig. 7 - Reverse Recovery Charge vs. Forward Current

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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